

300 W Transient Voltage Suppressor Rev. 1 — 6 March 2014

Product data sheet

1. **Product profile**

1.1 General description

300 W unidirectional Transient Voltage Suppressor (TVS) in a DFN2020-3 (SOT1061) leadless medium power Surface-Mounted Device (SMD) plastic package, designed for transient overvoltage protection.

1.2 Features and benefits

- Rated peak pulse power: PPPM = 300 W Reverse current: IRM = 1 nA
- Reverse standoff voltage range: V_{RWM} = 7.5 V to 26 V
- AEC-Q101 qualified

1.3 Applications

- Power supply protection
- Industrial application
- Power management

1.4 Quick reference data

Table 1. **Quick reference data**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
P _{PPM}	rated peak pulse power		[1][2]	-	300	W
V _{RWM}	reverse standoff voltage		7.5	-	26	V

[1] In accordance with IEC 61643-321 (10/1000 μ s current waveform).

[2] Measured from pin 1 and 2 to pin 3.

- Very low package height: 0.65 mm



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2. Pinning information

Table 2.	Pinning	
Pin	Description	Simplified outline Graphic symbol
1 and 2	anode	
3	cathode	3 4 1, 2 006aab838

3. Ordering information

Table 3. Ordering information					
Type number ^[1]	Package				
	Name	Description	Version		
PTVSxU1UPA series	DFN2020-3	plastic thermal enhanced ultra thin small outline package; no leads; 3 terminals; body $2 \times 2 \times 0.65$ mm	SOT1061		

[1] The series consists of 6 types with reverse standoff voltages from 7.5 V to 26 V.

4. Marking

Table 4. Marking codes	
Type number	Marking code
PTVS7V5U1UPA	CX
PTVS10VU1UPA	CY
PTVS12VU1UPA	CZ
PTVS15VU1UPA	D1
PTVS18VU1UPA	D2
PTVS26VU1UPA	D3

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5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
P _{PPM}	rated peak pulse power		<u>[1][3]</u>	-	300	W
			[2][3]	-	3000	W
I _{PPM}	rated peak pulse current			-	see <u>Table</u>	8
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	+150	°C
T _{stg}	storage temperature			-65	+150	°C

[1] In accordance with IEC 61643-321 (10/1000 μ s current waveform).

[2] In accordance with IEC 61000-4-5 and IEC 61643-321 (8/20 μs current waveform).

[3] Measured from pin 1 and 2 to pin 3.

Table 6.ESD maximum ratings

 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Max	Unit
V_{ESD}	electrostatic discharge voltage	IEC 61000-4-2 (contact discharge)	<u>[1][2]</u>	-	30	kV
		IEC 61000-4-2 (air discharge)	<u>[1][2]</u>	-	30	kV

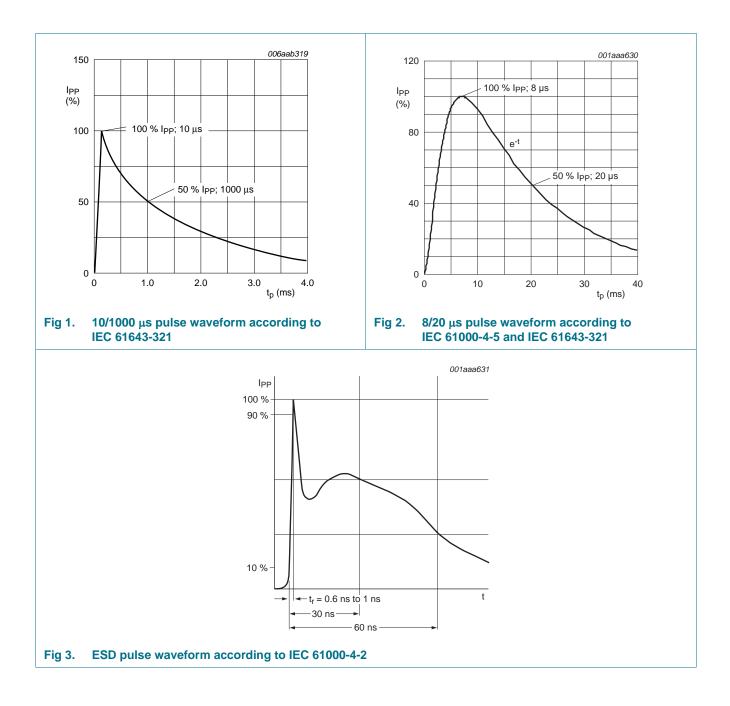
[1] Device stressed with ten non-repetitive ElectroStatic Discharge (ESD) pulses.

[2] Measured from pin 1 and 2 to pin 3.

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PTVSxU1UPA series

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6. Thermal characteristics

Table 7.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
-uiu-a)	thermal resistance from	in free air	<u>[1]</u> _	-	240	K/W
	junction to ambient		[2] _	-	120	K/W
			[3]	-	65	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		<u>[4]</u> _	-	10	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

[3] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

[4] Soldering point of cathode tab.

7. Characteristics

Table 8. Characteristics per type; PTVS7V5U1UPA to PTVS26VU1UPA

 $T_j = 25 \ ^{\circ}C$ unless otherwise specified.

Type number	Reverse standoff voltage V _{RWM} (V)	Breake V _{BR} (V I _R = 1		oltage	_	e e current) at V _{RWM}	Rated peak pulse current I _{PPM} (A) [1][3]	Rated peak pulse current I _{PPM} (A) [2][3]	Clamping voltage V _{CL} (V); at I _{PPM} (A) ^{[1][3]}	Clamping voltage V _{CL} (V); at I _{PPM} (A) ^{[2][3]}
	Max	Min	Тур	Max	Тур	Max	Max	Max	Max	Max
PTVS7V5U1UPA	7.5	8.33	8.77	9.21	200	1000	178	23.3	19.7	12.9
PTVS10VU1UPA	10	11.10	11.70	12.30	2	50	148	17.6	23.0	17.0
PTVS12VU1UPA	12	13.30	14.00	14.70	1	50	131	15.1	25.2	19.9
PTVS15VU1UPA	15	16.70	17.60	18.50	1	50	111	12.3	28.8	24.4
PTVS18VU1UPA	18	20.00	21.00	22.10	1	50	97	10.3	32.0	29.2
PTVS26VU1UPA	26	28.90	30.40	31.90	1	50	69	7.0	43.5	42.1

[1] In accordance with IEC 61000-4-5 and IEC 61643-321 (8/20 μs current waveform).

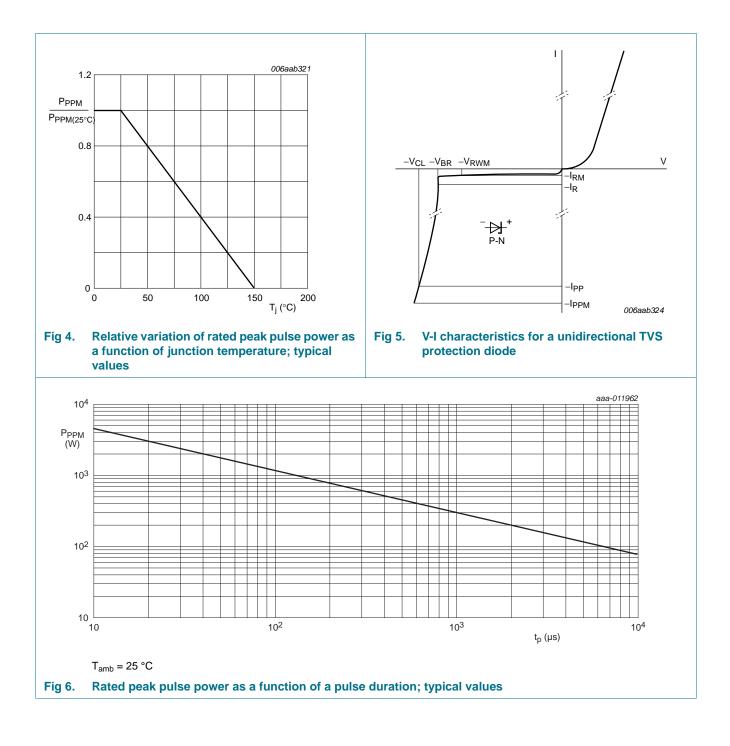
[2] In accordance with IEC 61643-321 (10/1000 μs current waveform).

[3] Measured from pin 1 and 2 to pin 3.

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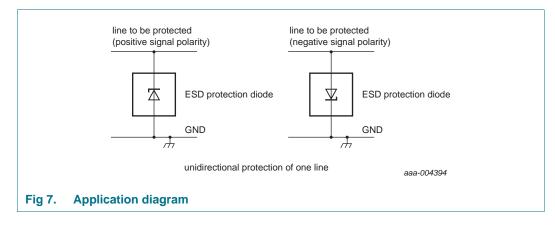
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8. Application information

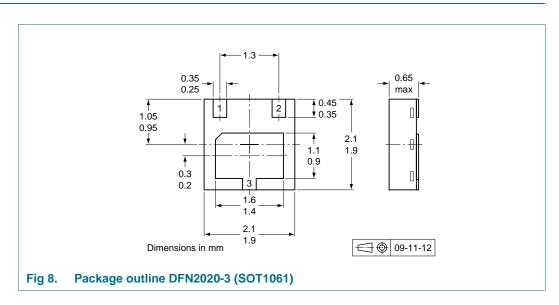


9. Test information

9.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

10. Package outline

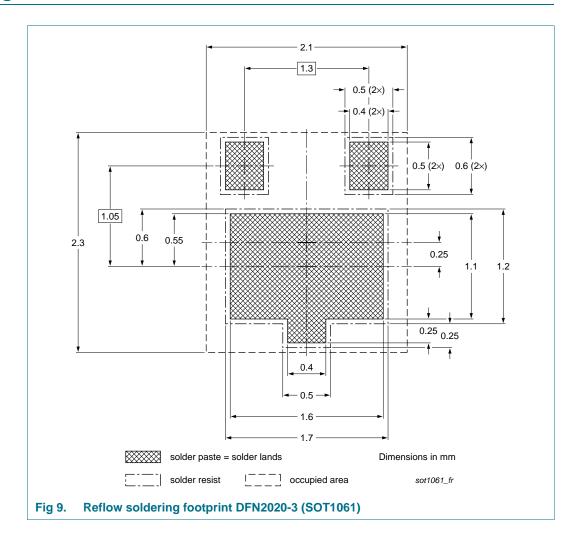


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11. Soldering



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12. Revision history

Table 9. Revision hist	Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
PTVSXU1UPA_SER v.1	20140306	Product data sheet	-	-		

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13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Date of release: 6 March 2014 Document identifier: PTVSXU1UPA_SER